

Features

Type

MPBW50N65E

- Easy parallel switching capability due to positive temperature coefficient in V_{CEsat}
- Low V_{CEsat}, fast switching
- High ruggedness, good thermal stability

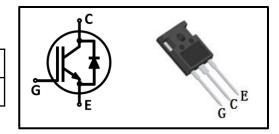
Marking

MP50N65E

Very tight parameter distribution

Applications

- UPS
- PFC
- PTC Heater
- Climate Compressor



Maximum Rated Values¹

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V _{CE}	650	V	
DC collector current ²	•			
T _c =25℃		80		
T _c =100°C		50		
Pulsed collector current ³	I _{Cpuls}	200		
Diode forward current ²	•	·	A	
T _c =25℃		80		
T _c =100°C		50	1	
Diode pulsed current ³	I _{Fpuls}	200		
Gate-emitter voltage	N	±20	- v	
Transient Gate-emitter voltage (t _p ≤10us)	- V _{GE}	±30		
Power dissipation				
T _c =25℃		300	W	
T _c =100°C	- P _{tot}	150		
Operating junction temperature	T _j -55~175		°⊂	
Storage temperature	T _{stg}	-55~150		

Package Code

TO-247-3

1:Reference standard: JESD-022 2: limited by Tjmax 3: Tp limited by Tjmax ;



Thermal Characteristics

Parameter	Symbol	Min	Тур	Max	Unit
IGBT thermal resistance, junction-case	R _{thJC}	-	-	0.5	
Diode thermal resistance, junction-case	R _{thJCD}	-	-	0.65	K/W
Thermal Resistance, junction-ambient	R _{thJA}	-	-	40	

Electrical Characteristics (at Tj=25°C, unless otherwise specified) Static Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter breakdown voltage	V _{(BR)CES}	V _{GE} =0V, I _C =0.25mA	650	-	-	
Collector-emitter		V _{GE} =15V, I _C =50A T _j =25℃	-	1.60	1.90	
saturation voltage	V _{CE(sat)}	Т _ј =125°С	-	1.72	-	
		Т _ј =150°С	-	1.80	-	V
		V _{GE} =0V, I _F =50A T _j =25℃	-	1.65	1.95	
Diode forward voltage	V _F	T _j =125°C	-	1.57	-	
		T _j =150°C	-	1.53	-	
G-E threshold voltage	V _{GE(th)}	I_{C} =1mA, V_{CE} = V_{GE}	4.5	5.5	6.5	
C-E leakage current	I _{CES}	V _{CE} =650V, V _{GE} =0V T _j =25℃	-	-	0.01	mA
	Γ	T _j =150°C	-	-	1.0	
G-E leakage current	I _{GES}	V _{CE} =0V, V _{GE} =20V	-	-	250	nA
Transconductance	9 _{FS}	V _{CE} =20V, I _C =50A	-	21	-	S

Dynamic Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Input capacitance	C _{iss}	\/25\/	-	5810	-	
Output capacitance	C _{oss}	V _{CE} =25V, V _{GE} =0V,	-	130	-	рF
Reverse transfer capacitance	C _{rss}	f=1MHz	-	65	-	
Gate charge	Q _G	V _{CC} =300V, I _C =50A, V _{GE} =15V	-	230	-	nC



IGBT Switching Characteristics

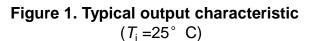
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Turn-on delay time	t _{d(on)}		-	89	-	
Rise time	t _r] T _i =25°C,	-	62	-	
Turn-off delay time	t _{d(off)}	V _{CC} =400V,	-	265	-	ns
Fall time	t _f	I _C =50A, V _{GF} =0/15V,	-	47	-	
Turn-on energy	E _{on}	$R_{g}=10\Omega$,	-	1.20	-	
Turn-off energy	E _{off}	Inductive load	-	1.12	-	mJ
Total switching energy	E _{ts}		-	2.32	-	
Turn-on delay time	t _{d(on)}		-	91	-	
Rise time	t _r	T _i =150°C.	-	63	-	
Turn-off delay time	t _{d(off)}	T _j =150°C, V _{CC} =400V,	-	302	-	ns
Fall time	t _f	I_{C} =50A, V_{GE} =0/15V, R_{G} =10 Ω , Inductive load	-	55	-	
Turn-on energy	Eon		-	1.91	-	
Turn-off energy	E _{off}		-	1.33	-	mJ
Total switching energy	E _{ts}		-	3.24	-	

Diode Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Diode reverse recovery time	t _{rr}		-	105	-	ns
Diode reverse recovery charge	Q _{rr}	T _j =25°C, V _R =400V, I _F =50A,	-	0.96	-	μC
Diode peak reverse recovery current	I _{rrm}	di _F /dt=600A/µs	-	14.8	-	А
Diode reverse recovery time	t _{rr}	T _i =150°C,		150		ns
Diode reverse recovery charge	Q _{rr}	V _R =400V, I _F =50A,		3.05		uC
Diode peak reverse recovery current	I _{rrm}	di _F /dt=600A/µs		33		А



200 V_{GE}=20V 175 V_{GE}=12V V_{GE}=15V 150 Ic, Collector Current(A) *V*_{GE}=10V 125 100 75 50 25 V_{GE}=8V 0 0 2 3 c, V_{CE} , Collector-Emitter Voltage(V)



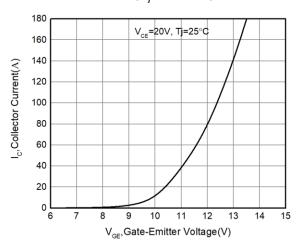


Figure 3. Typical transfer characteristic $(T_i = 25^{\circ} C)$

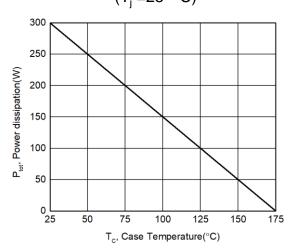


Figure 5. Power dissipation as a function of case temperature (TJ≤175°C)

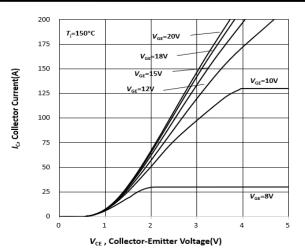


Figure 2. Typical output characteristic $(T_j = 150^{\circ} \text{ C})$

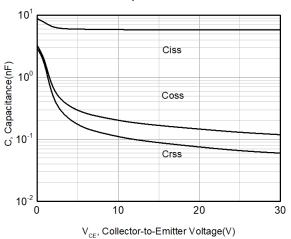


Figure 4. Capacitance characteristic (V_{GF}=0V, *f*=1MHz)

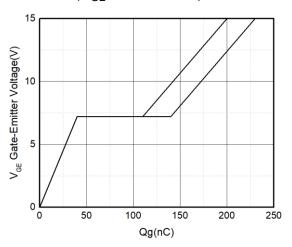


Figure 6. Typical gate charge (IC=50A)

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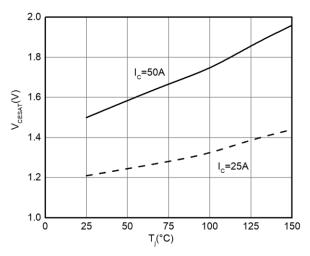


Figure 7. V_{CESAT} as a function of junction temperature (V_{GE}=15V)

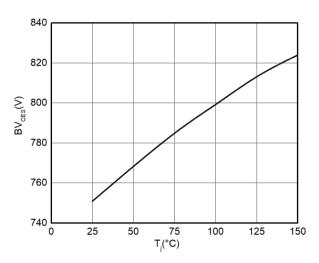


Figure 9. BV as a function of junction temperature ($I_{CF}=250uA$)

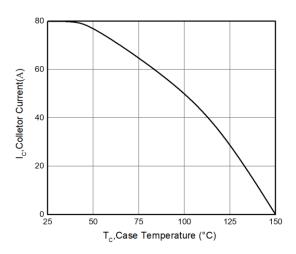


Figure 11. Collector current as a function of case Figure 12. $E_{on,} E_{off}$ as a function of IC temperature ($V_{GE} \ge 15V$, $T_i \le 150^{\circ}$ C) ($T_i = 25^{\circ}$ C) temperature($V_{GE} \ge 15V$, $T_i \le 150^{\circ}$ C)

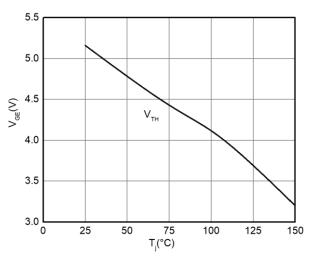


Figure 8. V_{TH} as a function of junction temperature (I_{CE}=250uA)

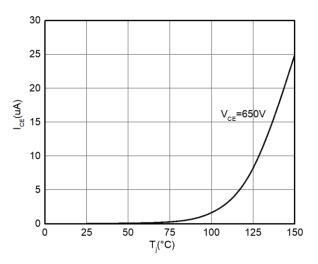
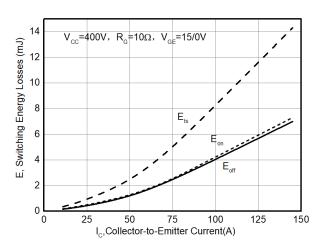


Figure 10. I_{CES} leakage current as a function of junction temperature





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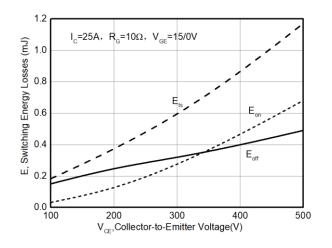


Figure 13. E_{on} , E_{off} as a function of V_{CE} (T_i =25° C)

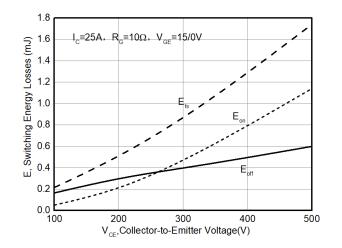


Figure 15. $E_{on,} E_{off}$ as a function of V_{CE} (T_i =150° C)

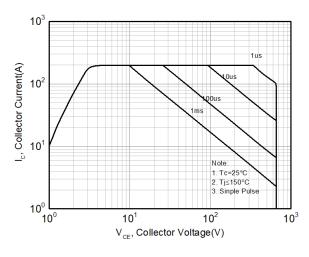


Figure 17. FBSOA

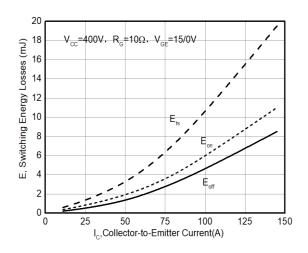


Figure 14. $E_{on,} E_{off}$ as a function of IC (T_j =150° C)

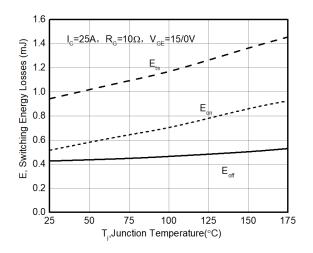
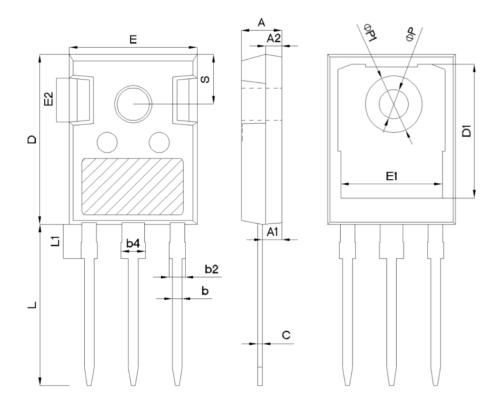


Figure 16. E_{on}, E_{off} as a function of junction temperature



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		mm	
SYMBOL	MIN	NOM	MAX
А	4.80	5.00	5.20
A1	2.21	2.41	2.61
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
с	0.51	0.61	0.75
D	20.70	21.00	21.30
D1	16.25	16.55	16.85
Е	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e		5.44BSC	
L	19.62	19.92	20.22
L1	-	-	4.30
ФР	3.40	3.60	3.80
ΦP1	-	-	7.30
S	6.15BSC		



Revision History:

Revision	Date	Subjects (major changes since last revision)
1.0	2020-12-27	Initial Version
1.1	2021-12-13	Update Electrical Characteristics and charts @T _j =25°C and @T _j =150°C
1.2	2022-01-07	Update Capacitance curve
1.3	2022-04-02	Update output characteristic @Tj=150°C



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